

RIBBON CABLE CONNECTORS





✓ Active

<u>+</u>

PRODUCT DRAWING



3D PDF

TE CONNECTIVITY (TE)

IDC LOW PRO HDR 14P VERT LG LA

AMP-LATCH | Low Profile Headers

2-1761606-5

TE Internal Number: 2-1761606-5

Always EU RoHS/ELV Compliant

Centerline 2.54 mm [.1 in]

PCB Mount Retention Without

PCB Mounting Orientation Vertical

Termination Method to PC Board Through Hole

Shrouded Yes

Product Drawings

HEADER ASSEMBLY, VERTICAL, LONG EJECT LATCH, LOW PROFILE, IDC

PDF **English**

CAD Files

3D PDF

PDF 3D

Customer View Model

3D_STP.ZIP English

Customer View Model

2D_DXF.ZIP English

Customer View Model

3D_IGS.ZIP English

Product Specifications

Product Specification AMP-LATCH And IDC Header Connectors, .100 X .100 Inch Grid

PDF **English**

Qualification Test Report Connector, AMP-LATCH Header, .100 X .100 Inch Grid

PDF **English**

Please review product documents or contact us for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

Product Type Features

PCB Mounting Orientation

Vertical

Shrouded

Yes

Row-to-Row Spacing

2.54 mm [.1 in]

DI.

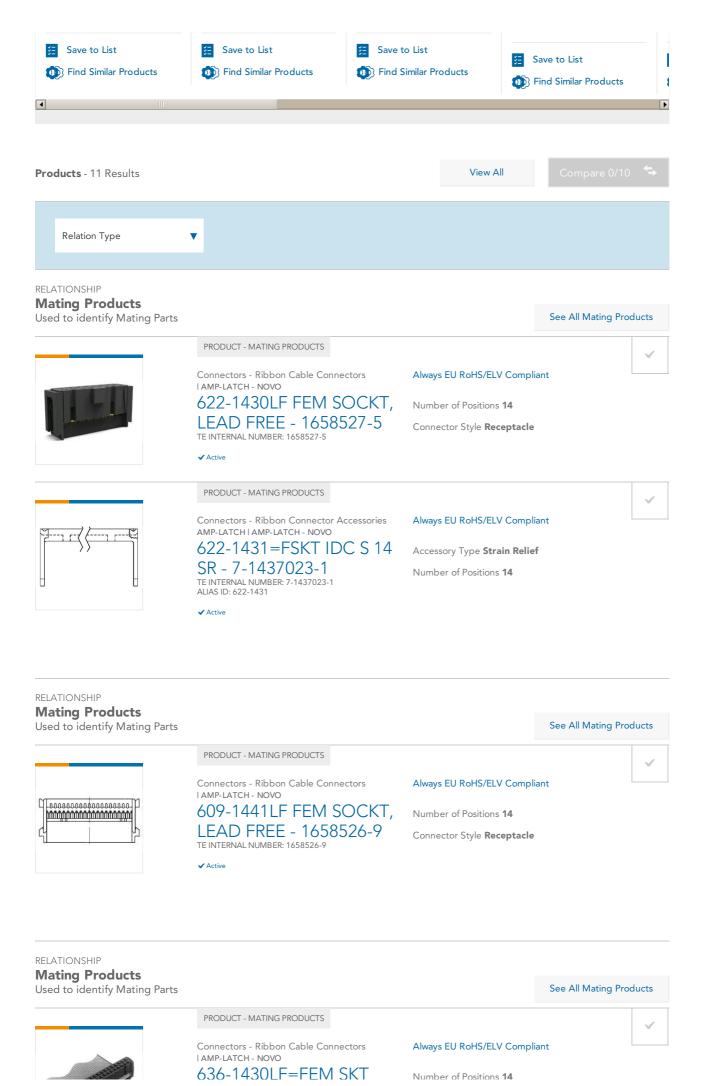
	Connector Style Flug		
	Profile	Low	
	Applies To	Printed Circuit Board	
	Product Type	Connector	
	Board Standoff	Without	
	Connector Type	Header	
	Connector System	Wire-to-Board	
	Ejection Latches	With	
Configuration Features	Number of Positions	14	
	Number of Rows	2	
Electrical Characteristics	Operating Voltage (VAC)	250	
Electrical Characteristics	Insulation Resistance (MΩ)	1000 - 5000	
	modulum resistance (M32)	1000 - 3000	
Body Features	Post Size	.64 mm [.025 in]	
	Header Type	Pin Header	
	Daisy Chain	With	
6			
Contact Features	Contact Mating Area Plating Material	Gold Flash over Palladium Nickel	
Contact Features	Contact Mating Area Plating Thickness	.762 μm [30 μin]	
Contact Features	Contact Mating Area Plating Thickness Contact Shape	.762 μm [30 μin] Square	
Contact Features	Contact Mating Area Plating Thickness Contact Shape Contact Transmits (Typical)	.762 μm [30 μin] Square Signal (Data)	
Contact Features	Contact Mating Area Plating Thickness Contact Shape Contact Transmits (Typical) Solder Tail Contact Plating Material	.762 μm [30 μin] Square Signal (Data) Tin over Nickel	
Contact Features	Contact Mating Area Plating Thickness Contact Shape Contact Transmits (Typical) Solder Tail Contact Plating Material Contact Current Rating (A)	.762 μm [30 μin] Square Signal (Data) Tin over Nickel	
Contact Features	Contact Mating Area Plating Thickness Contact Shape Contact Transmits (Typical) Solder Tail Contact Plating Material Contact Current Rating (A) Contact Base Material	.762 μm [30 μin] Square Signal (Data) Tin over Nickel 1 Phosphor Bronze	
Contact Features	Contact Mating Area Plating Thickness Contact Shape Contact Transmits (Typical) Solder Tail Contact Plating Material Contact Current Rating (A) Contact Base Material Contact Type	.762 μm [30 μin] Square Signal (Data) Tin over Nickel 1 Phosphor Bronze Pin	
Contact Features	Contact Mating Area Plating Thickness Contact Shape Contact Transmits (Typical) Solder Tail Contact Plating Material Contact Current Rating (A) Contact Base Material Contact Type Contact Termination Area Plating Material	.762 μm [30 μin] Square Signal (Data) Tin over Nickel 1 Phosphor Bronze Pin Tin	
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Contact Features Termination Features	Contact Mating Area Plating Thickness Contact Shape Contact Transmits (Typical) Solder Tail Contact Plating Material Contact Current Rating (A) Contact Base Material Contact Type Contact Termination Area Plating Material	.762 μm [30 μin] Square Signal (Data) Tin over Nickel 1 Phosphor Bronze Pin Tin	
	Contact Mating Area Plating Thickness Contact Shape Contact Transmits (Typical) Solder Tail Contact Plating Material Contact Current Rating (A) Contact Base Material Contact Type Contact Termination Area Plating Material Contact Termination Area Plating Thickness	.762 μm [30 μin] Square Signal (Data) Tin over Nickel 1 Phosphor Bronze Pin Tin 2.54 μm [100 μin]	
Termination Features	Contact Mating Area Plating Thickness Contact Shape Contact Transmits (Typical) Solder Tail Contact Plating Material Contact Current Rating (A) Contact Base Material Contact Type Contact Termination Area Plating Material Contact Termination Area Plating Thickness Termination Method to PC Board Termination Post Length	.762 μm [30 μin] Square Signal (Data) Tin over Nickel 1 Phosphor Bronze Pin Tin 2.54 μm [100 μin] Through Hole 2.6 mm [.102 in]	
	Contact Mating Area Plating Thickness Contact Shape Contact Transmits (Typical) Solder Tail Contact Plating Material Contact Current Rating (A) Contact Base Material Contact Type Contact Termination Area Plating Material Contact Termination Area Plating Thickness Termination Method to PC Board Termination Post Length PCB Mount Retention	.762 μm [30 μin] Square Signal (Data) Tin over Nickel 1 Phosphor Bronze Pin Tin 2.54 μm [100 μin] Through Hole 2.6 mm [.102 in]	
Termination Features	Contact Mating Area Plating Thickness Contact Shape Contact Transmits (Typical) Solder Tail Contact Plating Material Contact Current Rating (A) Contact Base Material Contact Type Contact Termination Area Plating Material Contact Termination Area Plating Thickness Termination Method to PC Board Termination Post Length PCB Mount Retention Mating Alignment Type	.762 μm [30 μin] Square Signal (Data) Tin over Nickel 1 Phosphor Bronze Pin Tin 2.54 μm [100 μin] Through Hole 2.6 mm [.102 in] Without Center	
Termination Features	Contact Mating Area Plating Thickness Contact Shape Contact Transmits (Typical) Solder Tail Contact Plating Material Contact Current Rating (A) Contact Base Material Contact Type Contact Termination Area Plating Material Contact Termination Area Plating Thickness Termination Method to PC Board Termination Post Length PCB Mount Retention	.762 μm [30 μin] Square Signal (Data) Tin over Nickel 1 Phosphor Bronze Pin Tin 2.54 μm [100 μin] Through Hole 2.6 mm [.102 in]	

	Polarization Panel Mount Retention Mating Retention PCB Mount Alignment	With Without With
Housing Features	Centerline Housing Color Housing Style Housing Entry Style Housing Material	2.54 mm [.1 in] Blue 4-Sided Top
Dimensions	Height Length Shrouded End Dimension	9.19 mm [.36 in] 25.4 mm [1 in] 3.76 mm [.148 in]
Usage Conditions	Temperature Rating Operating Temperature Range (°C)	High -65 – 105
Operation/Application	For Use With	AMP-Latch Receptacle
Industry Standards	UL Flammability Rating	UL 94V-0
Packaging Features	Packaging Method Packaging Quantity	Tube 20
Product Compliance	Statement of Compliance	

CUSTOMERS ALSO BOUGHT

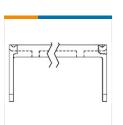
THROUGH-HOLE RESISTORS	RIBBON CABLE CONNECTORS	RJ45 CONNECTORS	MULTIPLE CONFIGURATION PCB HEADERS & RECEPTACLES	
SQM7 220R 5% (METAL FILM) SQMR7220RJ	IDC LOW PRO HDR 10P VERT BLUE 2-1761603-3	MJ ASSY, 2P, 8POS, R/A, PCB, CAT5 5406443-1	08 MODII HDR DRST B/A .100CL 103240-4	>

VIEW ALL PRODUCT COMPLIANCE





BLADE POL 1 - 1-1658528-2 TE INTERNAL NUMBER: 1-1658528-2



PRODUCT - MATING PRODUCTS

Connectors - Ribbon Connector Accessories AMP-LATCH | AMP-LATCH - NOVO

622-1431=FSKT IDC S 14 SR - 7-1437023-1 TE INTERNAL NUMBER: 7-1437023-1 ALIAS ID: 622-1431

✓ Active

Connector Style Receptacle

Always EU RoHS/ELV Compliant

Accessory Type Strain Relief

Number of Positions 14

